(Unit: mm)

PQ7DV10

Variable Output, (1.5 to 7V) 10A Output Low Power-loss Voltage Regulator

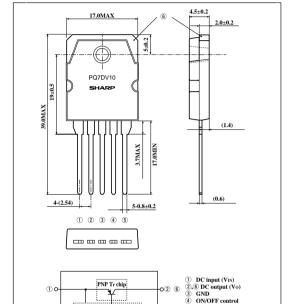
■ Feature

- 10A output type
- Low power-loss (Dropout voltage : MAX.0.5V at Io= 10A)
- Variable output type (1.5 to 7V)
- Low operating voltage (Minimum input voltage : 3.0V)
- High-precision reference voltage type (Reference voltage precision: ±2.0%)
- TO-3P package
- Built-in ON/OFF control function
- Built-in overcurrent protection, overheat protection function

Applications

 Power supplies for various electronic equipment such as personal computers

Outline Dimensions



terminal (Vc) Output voltage

-∩ (3)

adjustment terminal (VADJ)

■ Absolute Maximum Ratings

(Ta=25°C)

chip Controller

Parameter	Symbol	Rating	Unit
*1 Input voltage	Vin	10	V
*1 ON/OFF control terminal voltage	Vc	10	V
*1 Output adjustment terminal voltage	VADJ	5	V
Output current	Io	10	A
Power dissipation (No heat sink)	P _{D1}	2.2	W
Power dissipation (With infinite heat sink)	P _{D2}	60	W
*2 Junction temperature	Tj	150	.c
Operating temperature	Topr	-20 to +80	.с
Storage temperature	Tstg	-40 to +150	.с
Soldering temperature	Tsol	260 (For 10s)	·с

^{*1} All are open except GND and applicable terminals.

^{*2} Overheat protection may operate at 125<=Tj<=150°C.

■ Electrical Characteristics

(Unless otherwise specified, conditions shall be V IN=5V, Io=5A, Vo=3V(R1=2kΩ) Ta=25°C)

Parameter	Symbol	Conditions	NIN.	TYP.	MAX.	Unit
Input voltage	Vin	-	3	-	10	V
Reference voltage	Vo	-	1.5	-	7	V
Reference voltage	V_{ref}	-	1.225	1.25	1.275	V
Load regulation	RegL	Io=5mA to 10A	-	0.5	2	%
Line regulation	RegI	V _{IN} =4 to 10V	-	0.5	2.5	%
Temperature coefficient of output voltage	TcVo	T _j =0 to 125°C	-	±0.01	-	%/*C
Ripple rejection	RR	•	45	55	-	dB
Dropout voltage	Vi-o	VIN=3V, Io=10A	-	-	0.5	V
*3 ON-state voltage for control	Vc (ON)	•	2	-	-	V
ON-state current for control	Ic (on)	Vc=2.7V	-	-	20	$\mu \mathbf{A}$
OFF-state voltage for control	V _C (OFF)	·	-	-	0.8	V
OFF-state current for control	Ic (off)	Vc=0.4V	-	-	- 0.4	mA
Quiescent current	$\mathbf{I}_{\mathbf{q}}$	Io=0A	-	-	17	mA

^{*3} In case of opening control terminal 4,output voltage turns on.

Fig.1 Test Circuit

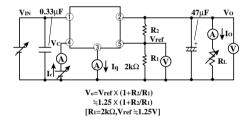
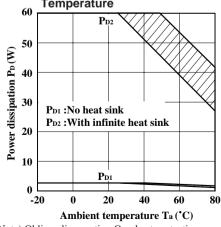


Fig.3 Power Dissipation vs. Ambient Temperature



Note) Oblique line portion:Overheat protection may operate in this area.

Fig.2 Test Circuit for Ripple Rejection

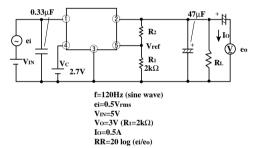


Fig.4 Overcurrent Protection Characteristics(Typical Value)

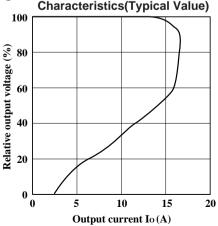


Fig.5 Output Voltage Adjustment Characteristics

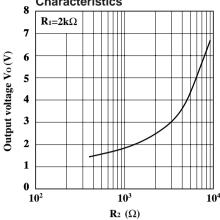


Fig.7 Output Voltage vs. Input Voltage

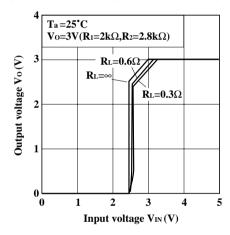


Fig.9 Dropout Voltage vs. Junction Temperature

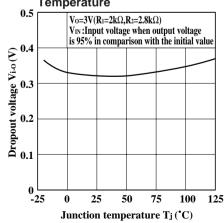


Fig.6 Output Voltage Deviation vs. Junction Temperature

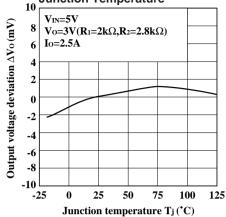


Fig.8 Circuit Operating Current vs. Input Voltage

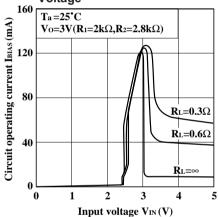
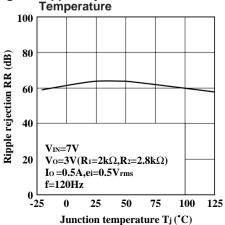


Fig.10 Ripple Rejection vs. Junction Temperature



Quiescent Current vs. Junction

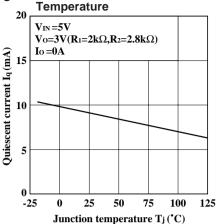
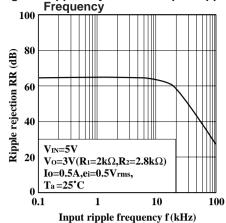
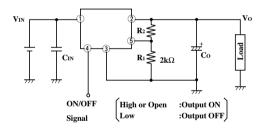


Fig.12 Ripple Rejection vs. Input Ripple Frequency 100



■ Typical Application



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